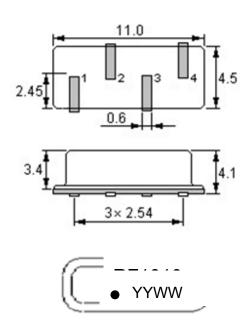
Application

- Low-loss SAW component
- Low amplitude ripple
- Sharp rejections at both out-bands
- Usable passband 1.5 MHz

Features

- RoHS compatible
- Package size 11.0x4.5x4.1mm³
- Package Code F11-SMD
- Electrostatic Sensitive Device(ESD)

Package Dimensions (Unit: mm)





Pin Configuration

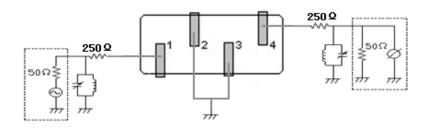
Pin No.	Description
1	Input
4	Output
2,3	Case Ground

Marking Description

	R	Trademark&	
RF		Manufacturer	
	F	SAW Filter	
1010	Part Number		
•	Pin 1		
YYWW	Year Code & Week Code		

*Fig: If the products produced in 06th week of 2015, The year code & week code is 1506.

Test Circuit (Bottom View)



Performance

Maximum Rating

Item		Value	Unit
DC Voltage	V _{DC}	3	V
Operation Temperature	Т	-40 ~ +85	${\mathbb C}$
Storage Temperature	T _{stg}	-55 ~ +125	${\mathbb C}$
RF Power Dissipation	Р	15	dBm

Electronic Characteristics

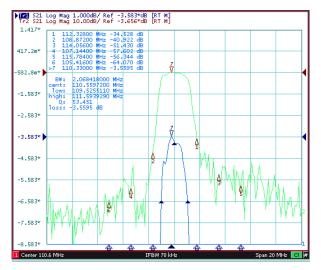
Test Temperature: 25 $^{\circ}$ C ± 2 $^{\circ}$ C

Terminating source impedance: 300Ω Terminating load impedance: 300Ω

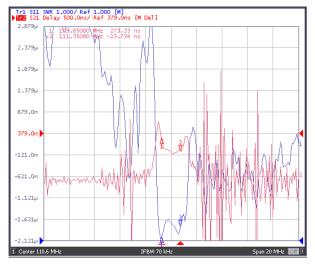
Item		Minimum	Typical	Maximum	Unit
Center Frequency	fc		110.592		MHz
Insertion Loss(min)	IL		3.5	4.5	dB
Insertion Loss 109.85-111.35MHz	IL		4.8	5.5	dB
Amplitude Ripple (p-p) 109.85-111.35MHz	Δa		1.2	1.8	dB
Group Delay Ripple 109.85-111.35MHz			500	800	ns
Absolute Attenuation	а				
DC-100.000 MHz		45.0	50.0		dB
105.416-107.144MHz		40.0	45.0		dB
107.144-108.872MHz		35.0	40.0		dB
112.328-114.056MHz		25.0	28.0		dB
114.056-115.784MHz		35.0	40.0		dB
150.000-800.000MHz		50.0	55.0		dB
Input VSWR 109.85-111.35MHz			2.0:1	2.5:1	/
Output VSWR 109.85-111.35MHz			2.0:1	2.5:1	/

Frequency Characteristics

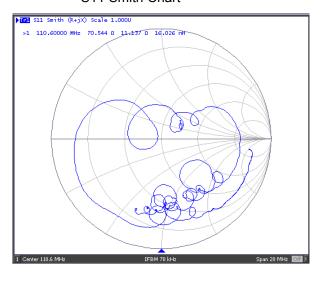
Frequency Response



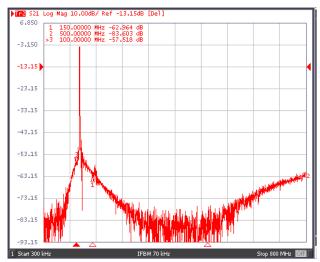
Delay Ripple & S11 VSWR



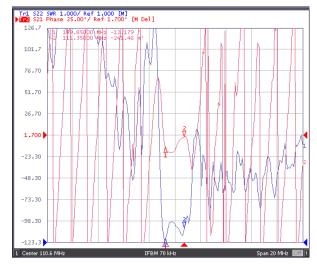
S11 Smith Chart



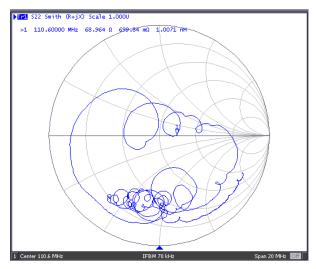
Frequency Response (wideband)



Phase Linearity & S22 VSWR



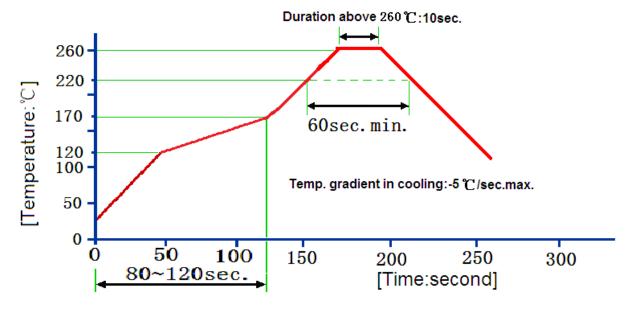
S22 Smith Chart



Reliability (The SAW components shall remain electrical performance after tests)

No.	Test item	Test condition		
1 Temperature		(1) Temperature: 85℃±2℃ , Duration: 250h , Recovery time: 2h±0.5h		
1	1 Storage	(2) Temperature: –55°C±3°C , Duration: 250h ,Recovery time: 2h±0.5h		
2	Humidity Test	Conditions: 60℃±2℃, 90~95% RH Duration: 250h		
3	2 Thermal Charle	Heat cycle conditions: TA=-55℃±3℃, TB=85℃±2℃, t1=t2=30min, Switch		
3 Thermal Shock		time: ≤3min, Cycle time: 100 times, Recovery time: 2h±0.5h.		
4	4 Vibration Fatigue	Frequency of vibration: 10~55Hz Amplitude:1.5mm		
	Vibration Latigue	Directions: X,Y and Z Duration: 2h		
5	Drop Test	Cycle time: 10 times Height: 1.0m		
		Temperature: 245 ℃ ±5 ℃ Duration: 3.0s5.0s		
6 Solder Ability Test	Depth: DIP2/3 , SMD1/5			
		(1)Thickness of PCB:1mm , Solder condition: 260 ℃±5 ℃ , Duration: 10±1s		
7	Resistance to Soldering Heat	(2)Temperature of Soldering Iron: 350℃±10℃, Duration: 3~4s,		
		Recovery time: 2 ± 0.5h		

Recommended Reflow Soldering Diagram



REYCONNS SAW Filter RF1010

Notes

1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.

- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may be soldered. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.